2SC4004

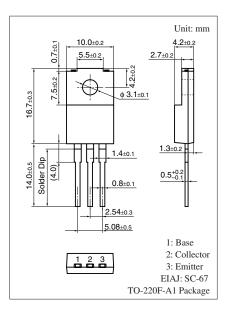
Silicon NPN triple diffusion planar type

For high breakdown voltage high-speed switching

Features

- High-speed switching
- High collector-base voltage (Emitter open) V_{CBO}
- Wide safe operation area
- \bullet Satisfactory linearity of forward current transfer ratio h_{FE}
- Full-pack package which can be installed to the heat sink with one screw

Absolute Maximum Ratings $T_C = 25^{\circ}C$ Parameter Symbol Rating Unit Collector-base voltage (Emitter open) 900 V V_{CBO} Collector-emitter voltage (E-B short) V_{CES} 900 V Collector-emitter voltage (Base open) V_{CEO} 800 V 7 Emitter-base voltage (Collector open) VEBO V Base current I_B 0.3 А А Collector current 1 I_C Peak collector current 2 А I_{CP} Collector power dissipation P_C 30 W $T_a = 25^{\circ}C$ 2.0°C Junction temperature Ti 150 Storage temperature T_{stg} -55 to +150 °C

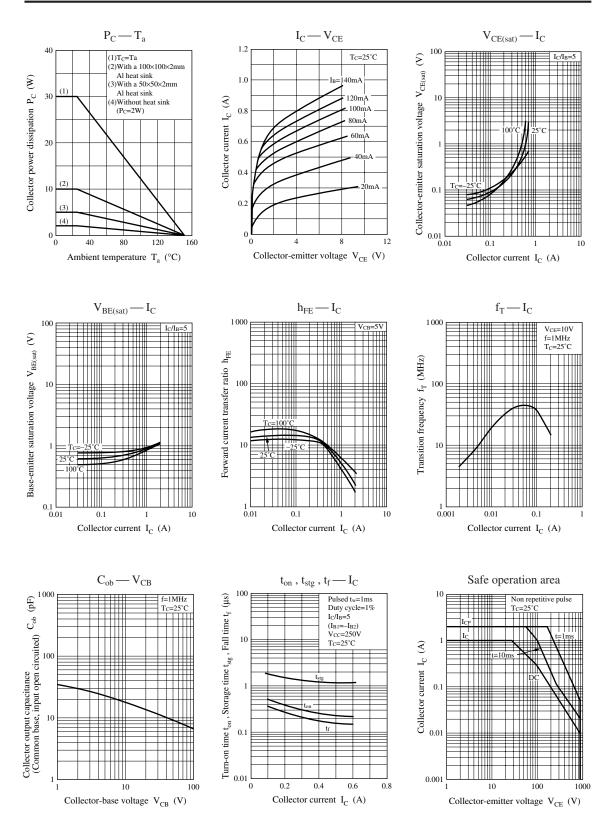


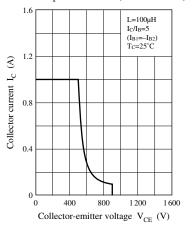
Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$	800			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 900 \text{ V}, I_E = 0$			50	μΑ
Emitter-base cutoff current (Collector open)	I _{EBO}	$V_{EB} = 7 V, I_C = 0$			50	μΑ
Forward current transfer ratio	h _{FE1}	$V_{CE} = 5 \text{ V}, I_C = 0.05 \text{ A}$	6			
	h _{FE2}	$V_{CE} = 5 \text{ V}, I_C = 0.5 \text{ A}$	3			
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 0.2 \text{ A}, I_{\rm B} = 0.04 \text{ A}$			1.5	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_C = 0.2 \text{ A}, I_B = 0.04 \text{ A}$			1.0	V
Transition frequency	f _T	$V_{CE} = 10 \text{ V}, I_C = 0.05 \text{ A}, f = 1 \text{ MHz}$		4		MHz
Turn-on time	t _{on}	$I_{\rm C} = 0.2 {\rm A}$			1.0	μs
Storage time	t _{stg}	$I_{B1} = 0.04 \text{ A}, I_{B2} = -0.04 \text{ A}$			3.0	μs
Fall time	t _f	$V_{CC} = 250 \text{ V}$			1.0	μs

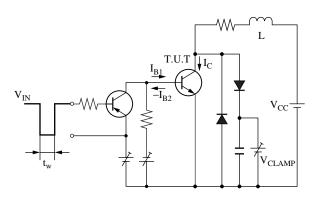
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

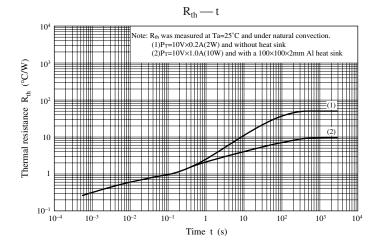
Panasonic





Safe operation area (Reverse bias) Safe operation area (Reverse bias) measurement circuit





SJD00125BED

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